TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSII)

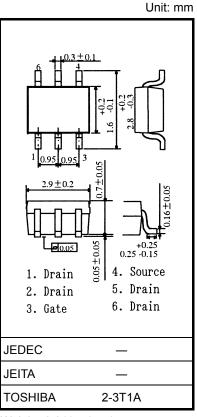
TPC6102

Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: RDS (ON) = $48 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 6 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = -10 \,\mu\text{A} \,(\text{max}) \,(V_{DS} = -30 \,\text{V})$
- Enhancement mode: $V_{th} = -0.8 \text{ to } -2.0 \text{ V (V}_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-30	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	-30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-4.5	Α	
	Pulse (Note 1)	I _{DP}	-18	A	
Drain power dissipation (t = 5 s) (Note 2a)		P_{D}	2.2	W	
Drain power dissipation (t = 5 s) (Note 2b)		P _D	0.7	W	
Single pulse avalanche energy (Note 3)		E _{AS}	3.3	mJ	
Avalanche current		I _{AR}	-2.25	Α	
Repetitive avalanche energy (Note 4)		E _{AR}	0.22	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

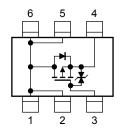
Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R _{th (ch-a)}	56.8	°C/W	
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W	

Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic- ensitive device. Please handle with caution.

Circuit Configuration





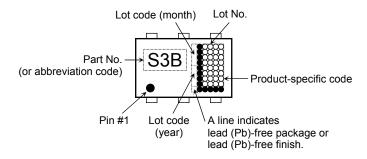
Electrical Characteristics (Ta = 25°C)

Ch	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА	
Drain cut-OFF current		I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА	
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	· v	
		V _{(BR) DSX}	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-15				
Gate threshold voltage		V _{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8		-2.0	٧	
Drain-source ON resistance		R _{DS} (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -2.2 \text{ A}$	_	78	100	mΩ	
		R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -2.2 \text{ A}$	_	48	60	1112.2	
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2.2 \text{ A}$	3.0	6.0		S	
Input capacitance		C _{iss}		_	500	_	pF	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	110	_		
Output capacitance		Coss		_	150	_		
Switching time	Rise time	t _r	$V_{GS} = \begin{array}{c} 0 \text{ V} \\ -10 \text{ V} \\ \hline \\ C \\ \hline \\ C \\ \hline \\ C \\ C \\ C \\ C \\ C$	_	3			
	Turn-ON time	t _{on}		_	7	_	ns	
	Fall time	t _f		_	31	_		
	Turn-OFF time	t _{off}	V _{DD} ≃ −15 V Duty ≦ 1%, t _W = 10 μs	_	79	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -24 \text{ V}, V_{GS} = -10 \text{ V},$		11	_	nC	
Gate-source charge		Q _{gs}	$I_D = -4.5 \text{ A}$	_	8.5	_		
Gate-drain ("miller") charge		Q _{gd}		_	2.5	_		

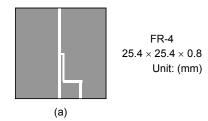
Source-Drain Ratings and Characteristics (Ta = 25°C)

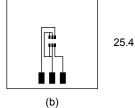
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Pulse drain reverse current (Note	1) I _{DRP}	_	_	_	-18	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = -4.5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

Marking (Note 5)



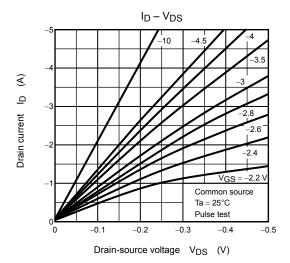
- Note 1: Ensure that the channel temperature does not exceed 150°C.
- Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)
 - (b) Device mounted on a glass-epoxy board (b) (t = 5 s)

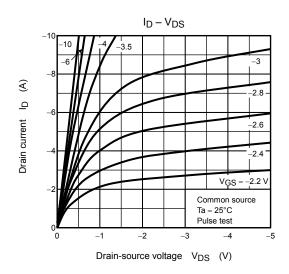


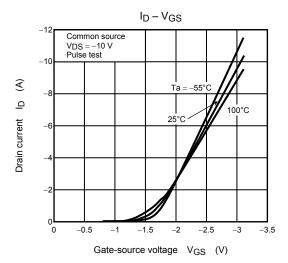


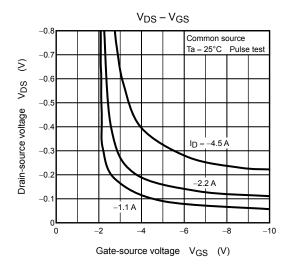
FR--4 $25.4 \times 25.4 \times 0.8$ Unit: (mm)

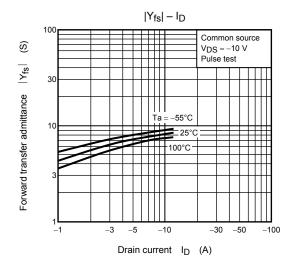
- Note 3: $V_{DD} = -24~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.5~mH, $R_G = 25~\Omega$, $I_{AR} = -2.25~A$
- Note 4: Repetitive rating: pulse width limited by maximum channel temperature
- Note 5: on lower left of the marking indicates Pin 1.

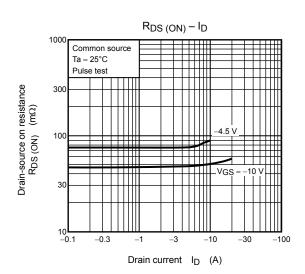


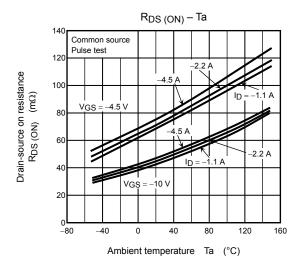


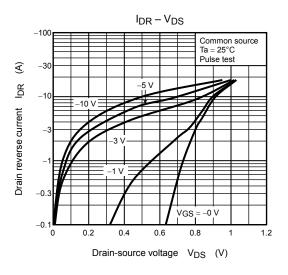


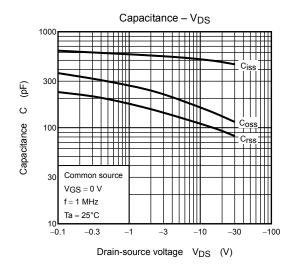


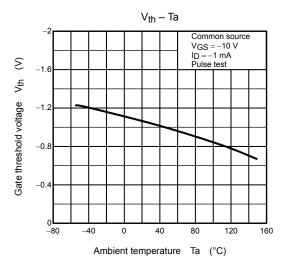


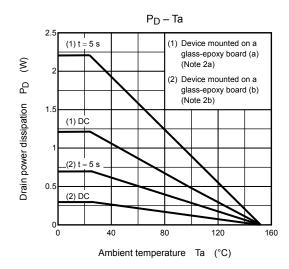


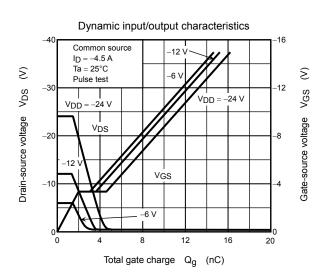




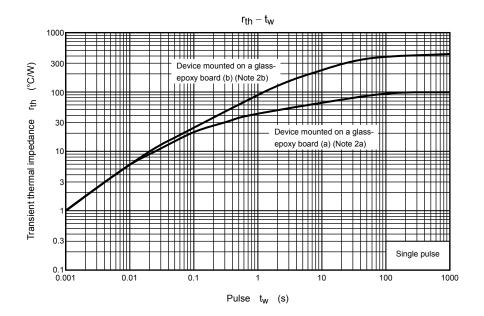


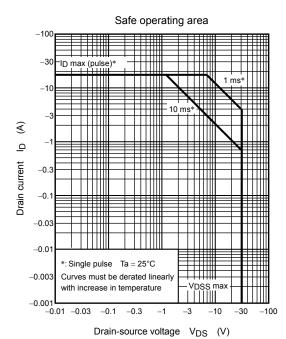






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